

NOTE:

1. MATERIALS

- . INSULATOR: HIGH TEMPERATURE THERMOPLASTIC UL94V-0
- . CONTACT: COPPER ALLOY, UNDER PLATING-NICKEL OVERALL. GOLD PLATED 10u" ON CONTACT
- . SHELL : SUS ( No Plating ). SOLDER TAIL AREA-TIN/LEAD.

2. MECHANICAL

- . RETENTION FORCE: 0.1kg MIN.

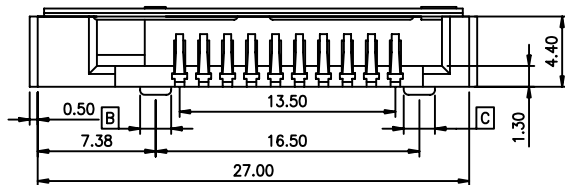
3. ELECTRICAL

- . VOLTAGE RATING: 100V AC.
- . INSULATION RESISTANCE: 1000 MEGOHMS MIN.
- . DIELECTRIC WITHSTANDING VOLTAGE: 500V AC .
- . CONTACT RESISTANCE: 40 MILLIOHMS MAX.
- . CURRENT RATING: 0.5 A.

4. ENVIRONMENT

OPERATION TEMPERATURE : -55°C ~ +85°C.

5. UNSPECIFIED TOLERANCE: .XX ±0.25[0.010] .X ±0.30[0.012]



<h1>XMULTIPLE</h1>		CONNECTING THE INFORMATION AGE	
XMULTIPLE ASIA 4F, No. 347, Yang Guang St., Neihu Chiu, Taipei, Taiwan 11475		XMULTIPLE USA 543 Country Club Drive #B 128 Simi Valley, CA 93065	
THIS DRAWING IS A CONTROLLED DOCUMENT.		CUSTOMER/NO:	
TITLE: MEMORY STICK CARD CONNECTOR		DWG NO: XMSC-0-10M4-K100-00	
PART NO: XMSC-0-10M4-K100-00		DRAWN: TARA	
		CHKD: JEFF	
		DATE: 13/10/04	
DIMENSIONS		SHEET	REV
mm[inch]		1 of 1	01